

IN THE UNITE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Kovarsky, et al.

Serial No.: 10/690,408

Confirmation No.: 7371

Filed:

October 21, 2003

For:

Copper Replenishment for

Copper Plating With Insoluble Anode

MAIL STOP AMENDMENT Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

ത ത ത ത ത ത ത ത ത ത ത ത

Group Art Unit: 1742

Examiner:

Harry D. Wilkins, III

CERTIFICATE OF MAILING 37 CFR 1.8

I hereby certify that this correspondence is being deposited on May 23, 2006 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

May 23, 2006

Date

B. Todd Patterson

RESPONSE TO OFFICE ACTION DATED FEBRUARY 23, 2006

In response to the Office Action dated February 23, 2006, having a shortened statutory period for response set to expire on May 23, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/008541/BTP, for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Specification begin on page 2 of this paper. Amendments to the Claims are reflected in the listing of claims which begins on page 5 of this paper. Remarks begin on page 8 of this paper.